

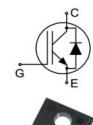
IGBT

Features

- 650V,15A
- V_{CE(sat)(typ.)}=1.9V@V_{GE}=15V,I_C=15A
- High speed switching
- Higher system efficiency
- Soft current turn-off waveforms
- Square RBSOA



JIAEN Trench IGBTs offer lower losses and higher energy efficiency for application such as Motor control, general inverter and other soft switching applications.





Absolute Maximum Ratings

| Symbol | Parameter | Value | Units |
|------------------|--|-------------|--------------|
| Vces | Collector-Emitter Voltage | 650 | V |
| V _{GES} | Gate-Emitter Voltage | <u>+</u> 30 | V |
| | Continuous Collector Current (Tc=25 °C) | 30 | А |
| lc | Continuous Collector Current (Tc=100°C) | 15 | А |
| Ісм | Pulsed Collector Current (Note 1) | 45 | А |
| I _F | Diode Continuous Forward Current (T _C =100 °C) | 15 | А |
| lғм | Diode Maximum Forward Current (Note 1) | 45 | А |
| tsc | Short Circuit Withstand Time | 10 | us |
| Б | Maximum Power Dissipation (T _C =25 °C) | 28 | W |
| P_D | Maximum Power Dissipation (T _C =100°C) | 11 | W |
| TJ | Operating Junction Temperature Range | -55 to +150 | $^{\circ}$ C |
| T _{STG} | Storage Temperature Range | -55 to +150 | $^{\circ}$ C |

Thermal Characteristics

| Symbol | Parameter | Max. | Units |
|---------------------|--|------|--------------|
| R _{th j-c} | Thermal Resistance, Junction to case for IGBT | 4.5 | °C/ W |
| R _{th j-c} | Thermal Resistance, Junction to case for Diode | 5.6 | °C/W |
| R _{th j-a} | Thermal Resistance, Junction to Ambient | 62.5 | °C/W |

Electrical Characteristics (Tc=25 °C unless otherwise noted)

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Units |
|----------------------|--------------------------------------|---|------|------|------|-------|
| BV _{CES} | Collector-Emitter Breakdown Voltage | V_{GE} = 0V, I_{C} = 250uA | 650 | - | - | V |
| I _{CES} | Collector-Emitter Leakage Current | V _{CE} = 650V, V _{GE} = 0V | - | - | 100 | uA |
| I _{GES} | Gate Leakage Current, Forward | $V_{GE}=\pm 20V$, $V_{CE}=0V$ | - | - | ±100 | nA |
| $V_{GE(th)}$ | Gate Threshold Voltage | $V_{GE} = V_{CE}$, $I_{C} = 250uA$ | 4.5 | - | 6.5 | V |
| V _{CE(sat)} | Collector-Emitter Saturation Voltage | V _{GE} =15V, I _C = 15A | - | 1.9 | 2.5 | V |
| Qg | Total Gate Charge | Vcc=480V | - | 40.7 | | nC |
| Qge | Gate-Emitter Charge | V _{GE} =15V | - | 4.19 | | nC |
| Qgc | Gate-Collector Charge | Ic=15A | - | 30.7 | | nC |
| t d(on) | Turn-on Delay Time | | - | 16 | - | ns |
| t r | Turn-on Rise Time | V _{CC} =400V | - | 20 | - | ns |
| t d(off) | Turn-off Delay Time | $V_{GE}=15V$ $I_{C}=15A$ $R_{G}=15\Omega$ Inductive Load $T_{C}=25~^{\circ}C$ | - | 94 | - | ns |
| t f | Turn-off Fall Time | | - | 118 | - | ns |
| Eon | Turn-on Switching Loss | | - | 0.31 | - | mJ |
| Eoff | Turn-off Switching Loss | | - | 0.32 | - | mJ |
| Ets | Total Switching Loss | | - | 0.63 | - | mJ |
| C _{ies} | Input Capacitance | Vce=25V | - | 629 | - | pF |
| Coes | Output Capacitance | V _{GE} =0V | - | 45 | - | pF |
| C _{res} | Reverse Transfer Capacitance | f = 1MHz | - | 7 | - | pF |

Electrical Characteristics of Diode (Tc=25°C unless otherwise noted)

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Units |
|----------------|-------------------------------------|------------------------|------|------|------|-------|
| V _F | Diode Forward Voltage | I _F =15A | - | 1.55 | 3.0 | V |
| trr | Diode Reverse Recovery Time | V _{CE} = 400V | - | 120 | | ns |
| Irr | Diode peak Reverse Recovery Current | I _F = 15A | - | 17.5 | | Α |
| Qrr | Diode Reverse Recovery Charge | Rg=15 Ω | - | 690 | | nC |

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature



Typical Performance Characteristics

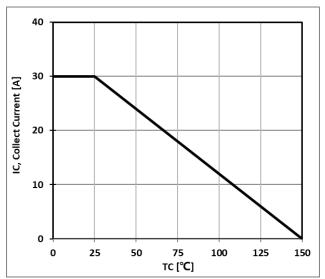


Figure 1: Maximum DC Collector Current VS. case temprature

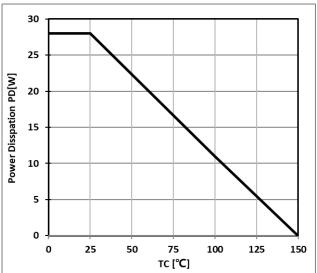


Figure 2: Power Dissipation VS. Case Temperature

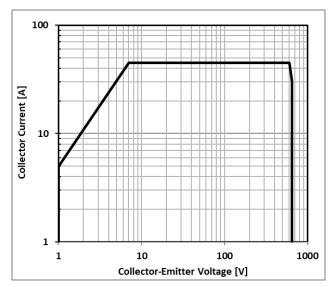


Figure 3: Reverse Bias SOA,TJ=125℃,VGE=15V

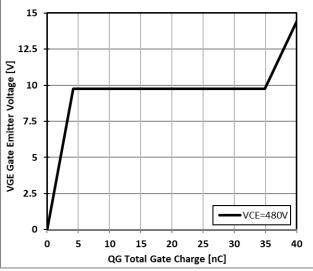


Figure 4: Typical Gate charge VS. VGE,IC=15A



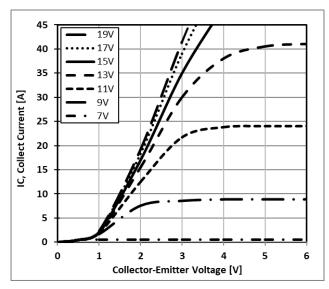


Figure 5: Typical IGBT Output characteristics, $TC=25^{\circ}C$;tp=300us

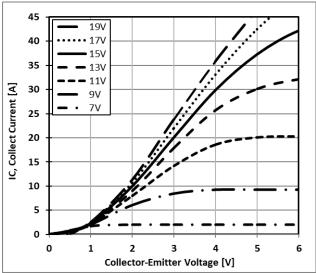


Figure 6: Typical IGBT Output characteristics, TC=150°C;tp=300us

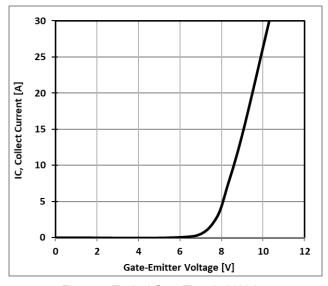


Figure 7: Typical Gate Threshold Voltage

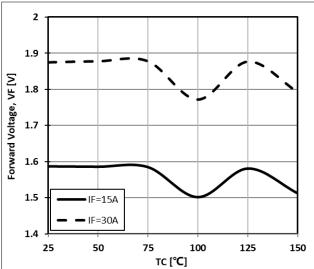


Figure 8: Typical Forward Voltage vs IF



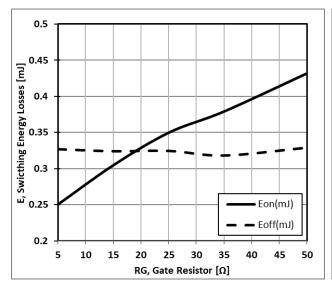


Figure 9: Typical Energy Loss VS. RG, TC=25°C, L=200uH,VCE=400V,VGE=15V,IC=15A

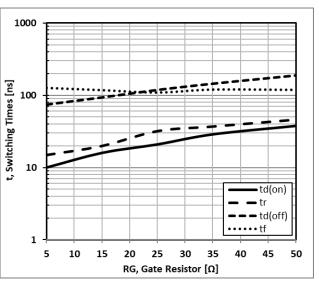


Figure 10: Typical Switching Time VS. RG, TC=25°C, L=200uH,VCE=400V,VGE=15V,IC=15A

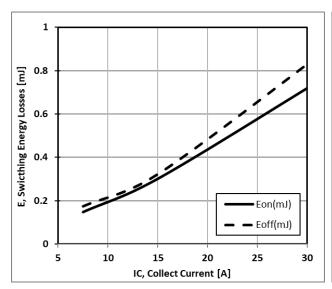


Figure 11: Typical Energy Loss VS. IC,TC=25 $^{\circ}$ C, L=200uH,VCE=400V,VGE=15V,RG=15 $^{\circ}$

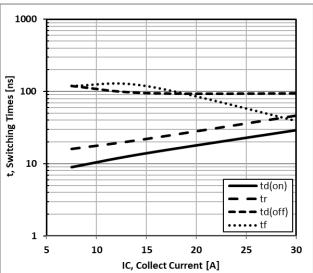


Figure 12: Typical Switching Time VS. IC,TC=25 $^{\circ}$ C, L=200uH,VCE=400V,VGE=15V,RG=15 $^{\circ}$



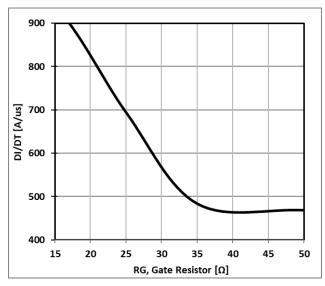


Figure 13: Typical Diode DI/DT VS. RG,TC=25°C VCC=400V, VGE=15V, IF=15A

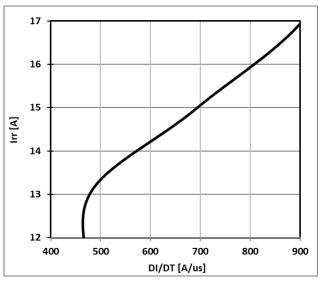


Figure 14: Typical Diode IRR VS. DI/DT,TC=25°C VCC=400V, VGE=15V, IF=15A

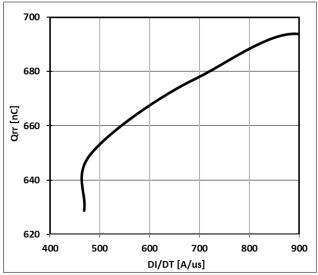


Figure 15: Typical Diode Qrr VS. DI/DT,TC=25℃ VCC=400V, VGE=15V, IF=15A

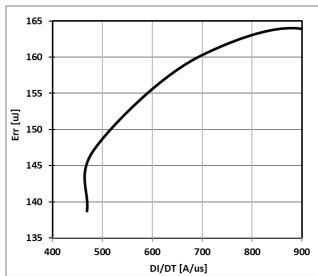
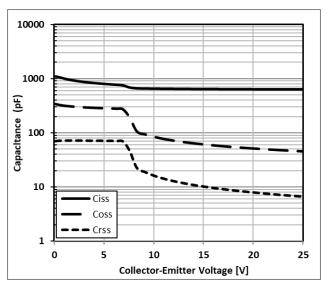
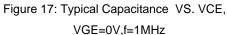


Figure 16: Typical Diode Err VS. DI/DT,TC=25 $^{\circ}$ C VCC=400V, VGE=15V, IF=15A







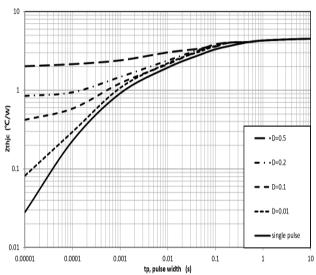
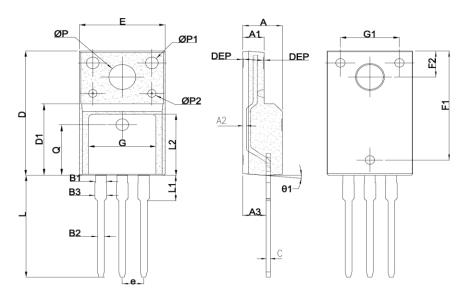


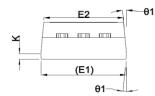
Figure 18: Normalized transient thermal impedance junction-to-case



TO-220F PACKAGE OUTLINE



| CO | MMON D | IMENSIO | NS | | |
|---------|--------|---------|--------|--|--|
| SYMBOL | mm | | | | |
| | MIN | NOM | MAX | | |
| *A | 4.50 | 4.70 | 4.90 | | |
| *A1 | 2.34 | 2.54 | 2.74 | | |
| *A2 | 0.38 | 0.43 | 0.48 | | |
| *A3 | 2.66 | 2.76 | 2.86 | | |
| B1 | 1.23 | 1.28 | 1.33 | | |
| *B2 | 0.75 | 0.80 | 0.85 | | |
| *B3 | 1.28 | - | 1.43 | | |
| *C | 0.45 | 0.50 | 0.60 | | |
| *[) | 15. 67 | 15.87 | 16.07 | | |
| *D1 | 9.04 | 9.12 | 9.20 | | |
| *e | 2.49 | 2.54 | 2.59 | | |
| *E | 10.00 | 10.16 | 10.32 | | |
| E1 | 9.94 | 10.04 | 10.14 | | |
| E2 | 9.36 | 9.46 | 9.56 | | |
| F1 | 13.80 | 13.90 | 14.00 | | |
| *F2 | 3. 20 | 3.30 | 3.40 | | |
| G | 7.80 | 8.00 | 8.20 | | |
| G1 | 6.90 | 7.00 | 7.10 | | |
| K | 0.65 | 0.70 | 0.75 | | |
| *L | 12.78 | 12.98 | 13. 18 | | |
| *L1 | 3.13 | 3, 23 | 3. 33 | | |
| L2 | 7.70 | 7.80 | 7.90 | | |
| Q | | 6.5REF | | | |
| *ΦP | 3.08 | - | 3.48 | | |
| фР1 | 1.40 | 1.50 | 1.60 | | |
| ф Р2 | 0.95 | 1.00 | 1.05 | | |
| * 0 1 | 3° | 5° | 7° | | |
| DEP | 0.05 | 0.10 | 0.15 | | |
| 带*为检验尺寸 | | | | | |



图中阴影为麻面Ra0.8-1.2, 其他面为亮面Ra0.2-0.4



Disclaimers

JIAEN Semiconductor Co., Ltd reserves the right to make changes without notice in order to improve reliability, function or design and to discontinue any product or service without notice. Customers should obtain the latest relevant information before orders and should verify that such information is current and complete. All products are sold subject to JIAEN's terms and conditions supplied at the time of order acknowledgement.

JIAEN Semiconductor Co., Ltd warrants performance of its hardware products to the specifications at the time of sale, Testing, reliability and quality control are used to the extent JIAEN deems necessary to support this warrantee. Except where agreed upon by contractual agreement, testing of all parameters of each product is not necessarily performed.

JIAEN Semiconductor Co., Ltd does not assume any liability arising from the use of any product or circuit designs described herein. Customers are responsible for their products and applications using JIAEN's components. To minimize risk, customers must provide adequate design and operating safeguards.

JIAEN Semiconductor Co., Ltd does not warrant or convey any license either expressed or implied under its parent rights, nor the rights of others. Reproduction of information in JIAEN's datasheets or data books sis permissible only if reproduction is without modification or alteration. Reproduction of this information with any alteration is an unfair and deceptive business practice. JIAEN Semiconductor Co., Ltd is not responsible or liable for such altered documentation.

Resale of JIAEN's products with statements different from or beyond the parameters stated by JIAEN Semiconductor Co., Ltd for that product or service voids all express or implied warrantees for the associated JIAEN's product or service and is unfair and deceptive business practice. JIAEN Semiconductor Co., Ltd is not responsible or liable for any such statements.